

NOT RECOMMENDED FOR NEW DESIGN **USE DMP2165UW**





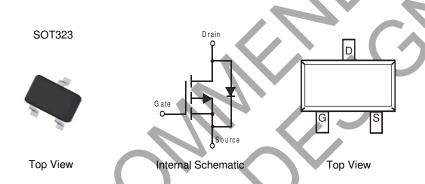
P-CHANNEL ENHANCEMENT MODE MOSFET

Features

- Low On-Resistance
- $100m\Omega$ @ $V_{GS} = -4.5V$
- $120m\Omega$ @ $V_{GS} = -2.5V$
- $160m\Omega @ V_{GS} = -1.8V$
- Very Low Gate Threshold Voltage V_{GS(TH)} ≤ 1V
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (DMP2160UWQ)

Mechanical Data

- Case: SOT323
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Alloy 42 Leadframe. Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 0.006 grams (Approximate)



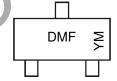
Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
DMP2160UW-7	Standard	SOT323	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



DMF = Marking Code YM = Date Code Marking Y = Year (ex: F = 2018)M = Month (ex: 9 = September)

Date Code Key

Year	2018		2019	2020		2021	2022		2023	2024		2025
Code	F		G	Н		I	J		K	L		М
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	g Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



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Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	-20	V
Gate-Source Voltage		V _{GSS}	±12	V
Drain Current (Note 5)	$T_A = +25$ °C $T_A = +70$ °C	I _D	-1.5 -1.2	А
Pulsed Drain Current		I _{DM}	-10	Α

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	P_{D}	350	mW
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	360	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

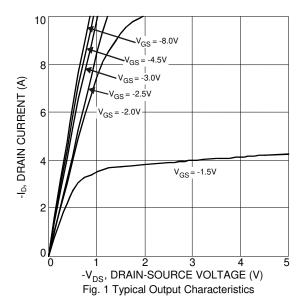
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)							
Drain-Source Breakdown Voltage	BV _{DSS}	-20	_	7	>	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current $T_J = +25^{\circ}C$	I _{DSS}		-	-1.0	μΑ	$V_{DS} = -20V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_		±100 ±800	nA	$V_{GS} = \pm 8V, V_{DS} = 0V$ $V_{GS} = \pm 12V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage	$V_{GS(TH)}$	-0.4	-0.6	-0.9	٧	$V_{DS} = V_{GS}$, $I_D = -250\mu A$	
Static Drain-Source On-Resistance	R _{DS(ON)}		75 90 120	100 120 160	mΩ	V _{GS} = -4.5V, I _D = -1.5A V _{GS} = -2.5V, I _D = -1.2A V _{GS} = -1.8V, I _D = -1A	
Forward Transconductance	g _F s	-	4	_	S	$V_{DS} = -10V, I_{D} = -1.5A$	
Diode Forward Voltage (Note 6)	V _{SD}	_	_	-1.0	٧	$V_{GS} = 0V$, $I_S = -1.0A$	
DYNAMIC CHARACTERISTICS							
Input Capacitance	C _{iss}	_	627	_	pF		
Output Capacitance	Coss	_	64	_	pF	$V_{DS} = -10V, V_{GS} = 0V$ f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	_	53	_	pF	1 - 1.01011 12	

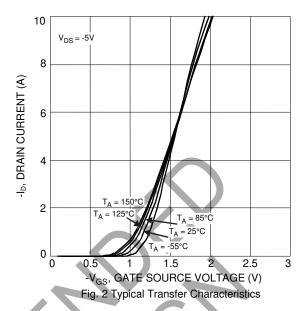
Notes: 5. Device mounted on 1inch² FR-4 PCB with 2 oz. Copper. t ≤ 10 sec. 6. Short duration pulse test used to minimize self-heating effect.

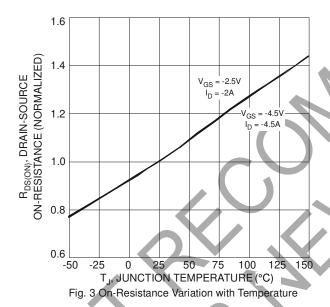


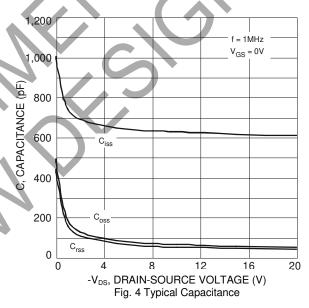
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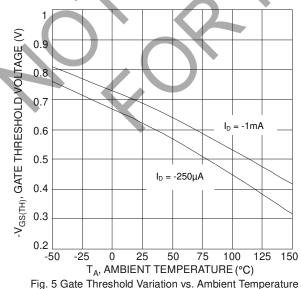
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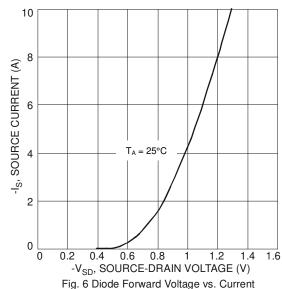


















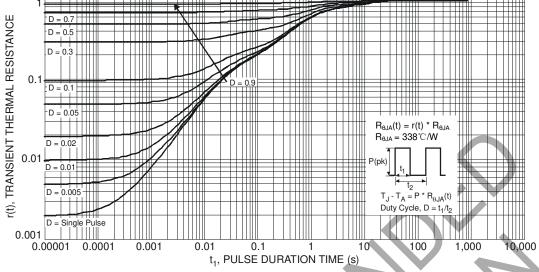


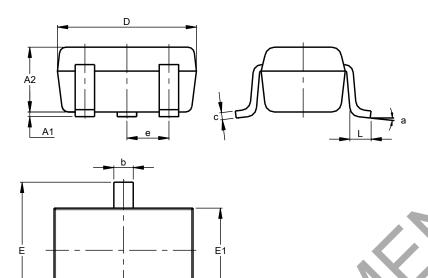
Fig. 7 Transient Thermal Response



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT323

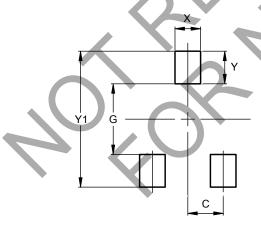


SOT323						
Dim	Min	Max	Тур			
A 1	0.00	0.10	0.05			
A2	0.90	1.00	0.95			
b	0.25	0.40	0.30			
С	0.10	0.18	0.11			
D	1.80	2.20	2.15			
Е	2.00	2.20	2.10			
E1	1.15	1.35	1.30			
е	0.650 BSC					
e1	1.20	1.40	1.30			
F	0.375	0.475	0.425			
L	0.25	0.40	0.30			
а	0°	8°				
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT323



Dimensions	Value (in mm)		
С	0.650		
G	1.300		
Х	0.470		
Υ	0.600		
V1	2 500		



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